

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_q max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

1.0

400

22

5.8

9.3

Single

 $V_{GS} = 10 V$

FEATURES

• Low gate charge Q_g results in simple drive requirement



- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching

TYPICAL SMPS TOPOLOGIES

- Single transistor flyback Xfmr. reset
- Single transistor forward Xfmr. reset (both US line input only)

| ORDERING INFORMATION | |
|---------------------------------|----------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRF730APbF |
| Lead (Pb)-free and halogen-free | IRF730APbF-BE3 |

| ABSOLUTE MAXIMUM RATINGS (T _C | = 25 °C, unl | ess otherwis | se noted) | | |
|---|-------------------------|---|-----------------|------|----------|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | V _{DS} | 400 | v | |
| Gate-source voltage | | V _{GS} | ± 30 | v | |
| Continuous drain current | V _{GS} at 10 V | T _C = 25 °C T _C = 100 °C | I _D | 5.5 | |
| | V _{GS} at 10 V | T _C = 100 °C | | 3.5 | А |
| Pulsed drain current ^a | | | I _{DM} | 22 | |
| Linear derating factor | | | 0.6 | W/°C | |
| Single pulse avalanche energy ^b | | E _{AS} | 290 | mJ | |
| Repetitive avalanche current ^a | | I _{AR} | 5.5 | A | |
| Repetitive avalanche energy ^a | | | E _{AR} | 7.4 | mJ |
| Maximum power dissipation | T _C = 25 °C | | PD | 74 | W |
| Peak diode recovery dV/dt ^c | | | dV/dt | 4.6 | V/ns |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C | |
| Soldering recommendations (peak temperature) ^d | For 10 s | | | 300 | |
| Mounting torque | 6-32 or M3 screw | | | 10 | lbf · in |
| Mounting torque | | | | 1.1 | N·m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Starting T_J = 25 °C, L = 19 mH, R_g = 25 Ω , I_{AS} = 5.5 A (see fig. 12)

c. $I_{SD} \le 5.5$ A, dl/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

S21-0853-Rev. C, 16-Aug-2021

1

Document Number: 91045

www.vishay.com

Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum junction-to-ambient | R _{thJC} | - | 1.70 | |
| Case-to-sink, flat, greased surface | R _{thCS} | 0.50 | - | °C/W |
| Maximum junction-to-case (drain) | R _{thJA} | - | 62 | |

| PARAMETER | SYMBOL | TES | ST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|------------|-----------|----------------------|------------------|
| Static | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} | = 0 V, I _D = 250 μA | 400 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Reference | ce to 25 °C, I _D = 1 mA | - | 0.5 | - | V/°C |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 2.0 | - | 4.5 | V |
| Gate-source leakage | I _{GSS} | | V _{GS} = ± 30 V | - | - | ± 100 | nA |
| Zero gate voltage drain current | I _{DSS} | | = 400 V, V _{GS} = 0 V /, V _{GS} = 0 V, T _J = 125 °C | - | - | 25 250 | μA |
| Drain-source on-state resistance | R _{DS(on)} | V _{GS} = 10 V | $I_{\rm D} = 3.3 {\rm A}^{\rm b}$ | - | _ | 1.0 | Ω |
| Forward transconductance | g _{fs} | | = 50 V, I _D = 3.3 A | 3.1 | - | - | S |
| Dynamic | 013 | | | | I | I | |
| Input capacitance | C _{iss} | $\gamma = -0 \gamma$ | | - | 600 | - | |
| Output capacitance | C _{oss} | - | V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5 | | 103 | - | 1 |
| Reverse transfer capacitance | C _{rss} | f = 1 | | | 4.0 | - | 1_ |
| · · · · | | V _{GS} = 0 V | V _{DS} = 1.0 V, f = 1.0 MHz | - | 890 | - | pF |
| Output capacitance | Coss | | V _{DS} = 320 V, f = 1.0 MHz | - | 30 | - | |
| Effective output capacitance | Coss eff. | | $V_{DS} = 0$ V to 320 V ^c | - | 45 | - | 1 |
| Total gate charge | Qg | | | - | - | 22 | |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 V$ | I _D = 3.5 A, V _{DS} = 320 V see fig. 6 and 13 ^b | - | - | 5.8 | nC |
| Gate-drain charge | Q _{gd} | | see lig. o and to | - | - | 9.3 | |
| Turn-on delay time | t _{d(on)} | | | - | 10 | - | |
| Rise time | t _r | | = 200 V, I _D = 3.5 A | - | 22 | - | |
| Turn-off delay time | t _{d(off)} | R _g = | 12 Ω, $R_D = 57 \Omega$, see fig. 10 ^b | - | 20 | - | ns |
| Fall time | t _f | | 5 | - | 16 | - | |
| Gate input resistance | Rg | f = 1 | MHz, open drain | 2.7 | - | 10.9 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | I _S | MOSFET symbol showing the | | - | - | 5.5 | Α |
| Pulsed diode forward current ^a | I _{SM} | integral revers p - n junction | | - | - | 22 | A |
| Body diode voltage | V _{SD} | T _J = 25 °C | , I _S = 5.5 A, V _{GS} = 0 V ^b | - | - | 1.6 | V |
| Body diode reverse recovery time | t _{rr} | T 05 %0 1 | | - | 370 | 550 | ns |
| Body diode reverse recovery charge | Q _{rr} | − T _J = 25 °C, I _F = 3.5 A, dl/dt = 100 A/μs ^b | | - | 1.6 | 2.4 | μC |
| Forward turn-on time | t _{on} | Intrinsic tu | ırn-on time is negligible (turn | -on is dor | ninated b | y L _S and | L _D) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

2



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

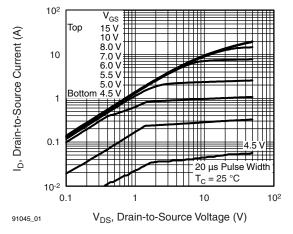


Fig. 1 - Typical Output Characteristics

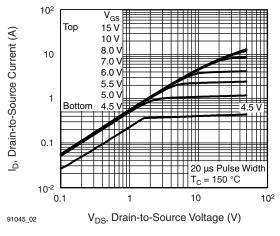


Fig. 2 - Typical Output Characteristics

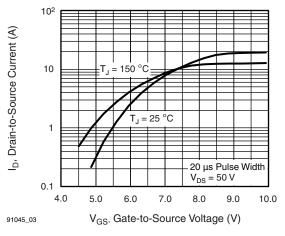


Fig. 3 - Typical Transfer Characteristics

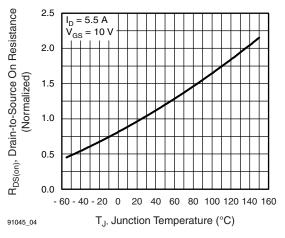


Fig. 4 - Normalized On-Resistance vs. Temperature

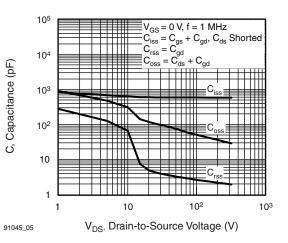


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

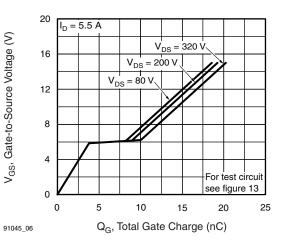


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000





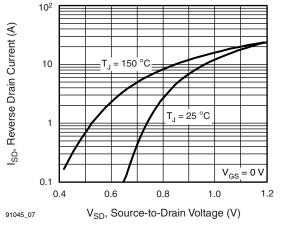


Fig. 7 - Typical Source-Drain Diode Forward Voltage

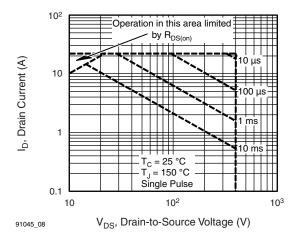


Fig. 8 - Maximum Safe Operating Area

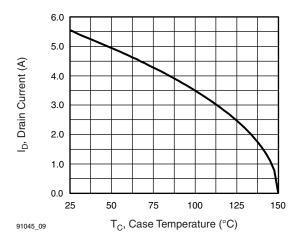


Fig. 9 - Maximum Drain Current vs. Case Temperature

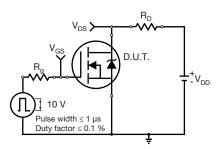


Fig. 10 - Switching Time Test Circuit

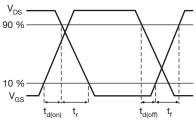
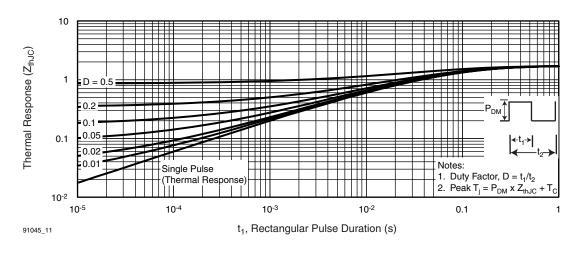


Fig. 11 - Switching Time Waveforms



S21-0853-Rev. C, 16-Aug-2021

4

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix

Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

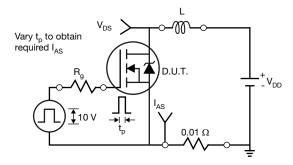


Fig. 13 - Unclamped Inductive Test Circuit

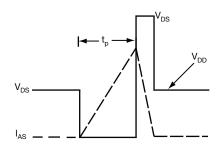


Fig. 14 - Unclamped Inductive Waveforms

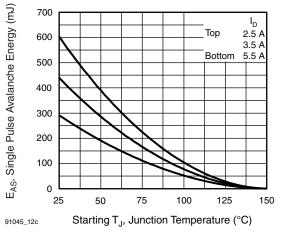


Fig. 15 - Maximum Avalanche Energy vs. Drain Current



Fig. 16 - Typical Drain Source Voltage vs. Avalanche Current

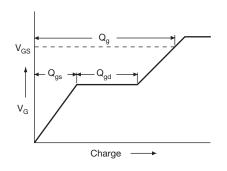


Fig. 17 - Basic Gate Charge Waveform

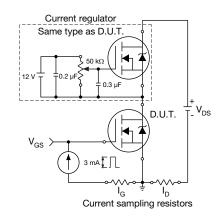
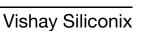
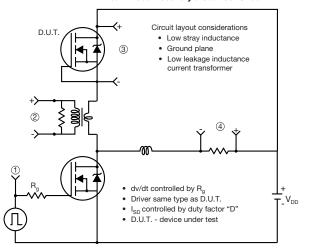


Fig. 18 - Gate Charge Test Circuit





Peak Diode Recovery dv/dt Test Circuit



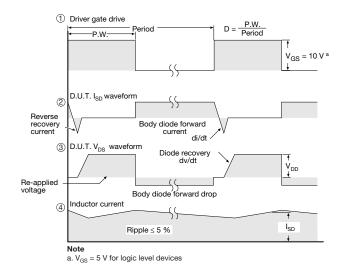


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91045.

6



Vishay Siliconix

TO-220-1



| DIM. | MILLIN | METERS | INC | HES |
|------|--------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| А | 4.24 | 4.65 | 0.167 | 0.183 |
| b | 0.69 | 1.02 | 0.027 | 0.040 |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 |
| С | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.33 | 15.85 | 0.564 | 0.624 |
| E | 9.96 | 10.52 | 0.392 | 0.414 |
| е | 2.41 | 2.67 | 0.095 | 0.105 |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 |
| F | 1.14 | 1.40 | 0.045 | 0.055 |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 |
| L | 13.36 | 14.40 | 0.526 | 0.567 |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 |
| ØP | 3.53 | 3.94 | 0.139 | 0.155 |
| Q | 2.54 | 3.00 | 0.100 | 0.118 |

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 US6M2GTR TK10A80W,S4X(S SSM6P69NU,LF